

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Common-mode chokes, ring core 0.47 ... 4.7 mH, 300 ... 600 mA, 60 °C

Series/Type: B82792C2

Date: April 2008

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B82792C2

#### Common-mode chokes, ring core

**SMD** 

Rated voltage 42 V AC/80 V DC
Rated inductance 0.47 mH to 4.7 mH
Rated current 300 mA to 600 mA

# PROPERTY OF STREET

#### Construction

- Current-compensated ring core quad choke
- Ferrite core
- LCP case (UL 94 V-0)
- Silicone potting
- Bifilar winding

#### **Features**

- Suitable for reflow soldering
- RoHS-compatible

#### **Function**

Suppression of asymmetrical interference coupled in on lines, whereas data signals up to some MHz can pass unaffectedly.

#### **Applications**

- Telecom applications
- RF equipment

#### **Terminals**

- Base material CuSn6
- Layer composition Ni, Sn
- Hot-dipped

#### Marking

- Marking on component:
   Manufacturer, ordering code inductance,
   date of manufacture (YYMMD)
- Minimum data on reel:
   Manufacturer, ordering code, L value and tolerance, quantity, date of packing

#### Delivery mode and packing unit

- 24-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 500 pcs./reel



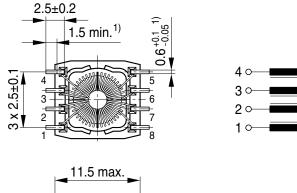


#### Common-mode chokes, ring core

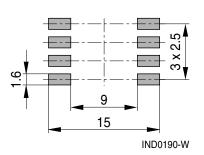
## **SMD**

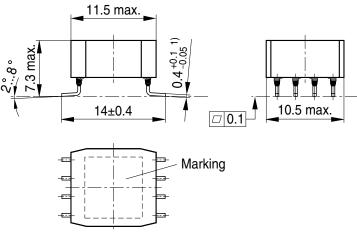
**⊘ 8** 

#### Dimensional drawing and pin configuration



#### Layout recommendation





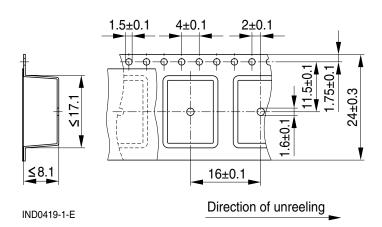
1) Soldering area

IND0189-Q-E

Dimensions in mm

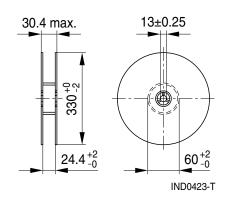
#### Taping and packing

#### Blister tape



Dimensions in mm

## Reel





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## Common-mode chokes, ring core

## **SMD**

## Technical data and measuring conditions

Rated voltage V <sub>R</sub>	42 V AC (50/60 Hz) / 80 V DC			
Rated temperature T <sub>R</sub>	60 °C			
Rated current I <sub>R</sub>	Referred to 50 Hz and rated temperature			
Rated inductance L <sub>R</sub>	Measured with Agilent 4284A at 50 mV, 20 °C Measuring frequency: $L_R \le 1$ mH = 100 kHz $L_R > 1$ mH = 10 kHz Inductance is specified per winding.			
Inductance tolerance	-30%/+50% at 20 °C			
Inductance decrease $\Delta L/L_0$	< 10% at DC magnetic bias with I <sub>R</sub> , 20 °C			
Stray inductance L <sub>stray,typ</sub>	Measured with Agilent 4284A at 50 mV, 20 °C, typical values $ \text{Measuring frequency: } L_{\text{R}} \leq 1 \text{ mH} = 100 \text{ kHz} \\ L_{\text{R}} > 1 \text{ mH} = 10 \text{ kHz} $			
DC resistance R <sub>typ</sub>	Measured at 20 °C, typical values, specified per winding			
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: $(245 \pm 5)$ °C, $(3 \pm 0.3)$ s Wetting of soldering area $\geq 95\%$ (to IEC 60068-2-58)			
Resistance to soldering heat	(260 ±5) °C, (10 ±1) s (to IEC 60068-2-58)			
Climatic category	40/125/56 (to IEC 60068-1)			
Storage conditions (packaged)	–25 °C +40 °C, ≤ 75% RH			
Weight	Approx. 2 g			
·				

## **Characteristics and ordering codes**

L <sub>R</sub> mH	L <sub>stray,typ</sub> nH	I <sub>R</sub> mA	$R_{typ}$ $m\Omega$	V <sub>test</sub> V DC, 2 s	Ordering code
0.47	200	600	220	750	B82792C2474N315
1.0	200	500	170	750	B82792C2105N365
4.7	300	300	700	750	B82792C2475N365



#### Common-mode chokes, ring core

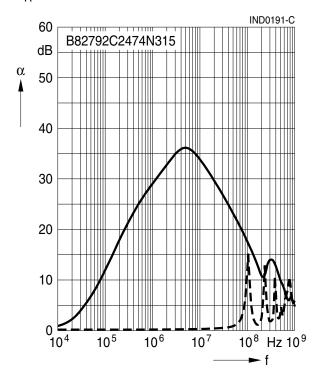
#### **SMD**

**Insertion loss**  $\alpha$  (typical values at  $|Z| = 50 \Omega$ , 20 °C)

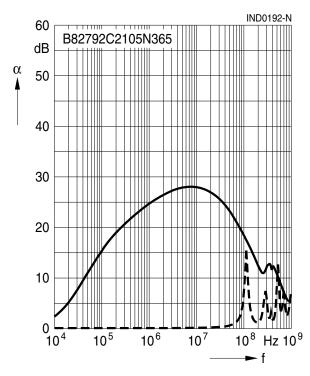
asymmetrical, all branches in parallel (common mode)

- - - - - - symmetrical (differential mode)

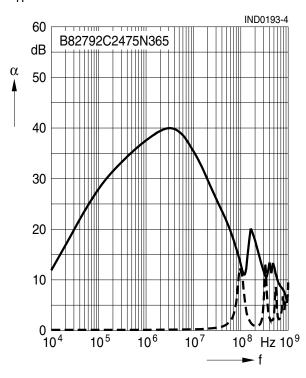
$$L_{R} = 0.47 \text{ mH}$$



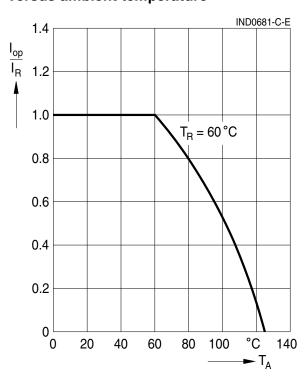
$$L_{R} = 1.0 \text{ mH}$$



 $L_R = 4.7 \text{ mH}$ 



Current derating I<sub>op</sub>/I<sub>R</sub> versus ambient temperature





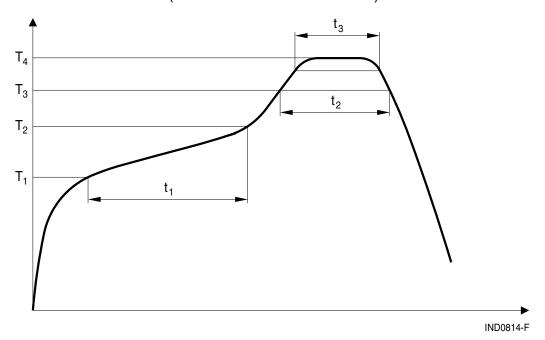
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## Common-mode chokes, ring core

**SMD** 

## Recommended reflow soldering curve

Pb-free solder material (based on JEDEC J-STD 020C)



T <sub>1</sub>	T <sub>2</sub>	T <sub>3</sub>	T <sub>4</sub>	t <sub>1</sub>	t <sub>2</sub>	t <sub>3</sub>
°C	°C	°C	°C	S	S	s
150	200	217	250	< 110	< 90	< 30 @ T <sub>4</sub> –5 °C

Time from 25  $^{\circ}$ C to T<sub>4</sub>: max 300 s Maximal numbers of reflow cycles: 3



#### **Cautions and warnings**

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



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The following applies to all products named in this publication:

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- We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
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